TO-220 FULLPACK, 3-LEAD (ULTRA NARROW LEAD)

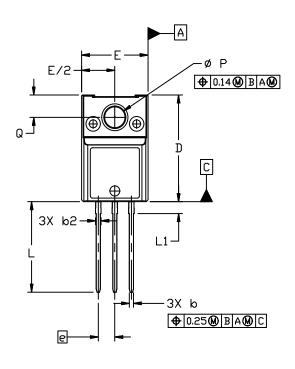
CASE 221BN ISSUE A

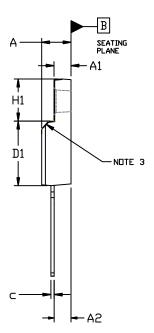
DATE 07 MAY 2021



NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 2. CONTROLLING DIMENSION: MILLIMETERS
- B. CONTOUR UNCONTROLLED IN THIS AREA.
- DIMENSIONS EXCLUDE BURRS, MOLD FLASH, AND TIE BAR PROTRUSIONS.





	MILLIMETERS			
DIM	MIN.	N□M.	MAX.	
Α	4.60	4.70	4.80	
A1	2.50	2.60	2.70	
A2	2.47	2.57	2.67	
م	0.56	0.63	0.69	
b2			0.90	
C	0.46	0.53	0.59	
D	15.80	16.00	16.20	
D1	9.58	9.68	9.78	
E	10.00	10.20	10.40	
е	2.54 BSC			
H1	6.32 REF			
L	13.45	13.60	13.75	
L1	1.70	1.80	1.90	
P	3.00	3.10	3.20	
Q	3.25	3.35	3,45	

GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code

A = Assembly Location

Y = Year

WW = Work Week

■ = Pb-Free Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION: TO-220 FULLPACK, 3-LEA		AD (ULTRA NARROW LEAD)	PAGE 1 OF 1

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